

0104-0347P

U.S. APPLICATION NO. (If known, see 37 CFR 1.5)

09/869119

TRANSMITTAL LETTER TO THE UNITED STATES DESIGNATED/ELECTED OFFICE (DO/EO/US) CONCERNING A FILING UNDER 35 U.S.C. 371		ATTORNEY'S DOCKET NUMBER 0104-0347P U.S. APPLICATION NO. (If known, see 37 CFR 1.5) 09/869119
INTERNATIONAL APPLICATION NO. PCT/SE00/00097	INTERNATIONAL FILING DATE January 18, 2000	PRIORITY DATE CLAIMED January 18, 1999
TITLE OF INVENTION SYSTEM FOR PRODUCTION OF LARGE AREA DISPLAY PANELS WITH IMPROVED PRECISION		
APPLICANT(S) FOR DO/EO/US EKBERG, Peter		
Applicant herewith submits to the United States Designated/Elected Office (DO/EO/US) the following items and other information:		
<p>1. <input checked="" type="checkbox"/> This is a FIRST submission of items concerning a filing under 35 U.S.C. 371.</p> <p>2. <input type="checkbox"/> This is a SECOND or SUBSEQUENT submission of items concerning a filing under 35 U.S.C. 371.</p> <p>3. <input checked="" type="checkbox"/> This express request to begin national examination procedures (35 U.S.C. 371(f)) at any time rather than delay examination until the expiration of the applicable time limit set in 35 U.S.C. 371(b) and PCT Articles 22 and 39 (1).</p> <p>4. <input type="checkbox"/> The US has been elected by the expiration of 19 months from the priority date (Article 31).</p> <p>5. <input checked="" type="checkbox"/> A copy of the International Application as filed (35 U.S.C. 371(c)(2))</p> <ol style="list-style-type: none"> <input type="checkbox"/> is transmitted herewith (required only if not transmitted by the International Bureau). <input checked="" type="checkbox"/> has been transmitted by the International Bureau. WO 00/42630 <input type="checkbox"/> is not required, as the application was filed in the United States Receiving Office (RO/US). <p>6. <input checked="" type="checkbox"/> An English language translation of the International Application as filed (35 U.S.C. 371(c)(2)).</p> <ol style="list-style-type: none"> <input checked="" type="checkbox"/> is transmitted herewith. <input type="checkbox"/> has been previously submitted under 35 U.S.C. 154(d)(4) <p>7. <input checked="" type="checkbox"/> Amendments to the claims of the International Application under PCT Article 19 (35 U.S.C. 371(c)(3)).</p> <ol style="list-style-type: none"> <input type="checkbox"/> are transmitted herewith (required only if not transmitted by the International Bureau). <input type="checkbox"/> have been transmitted by the International Bureau. <input type="checkbox"/> have not been made; however, the time limit for making such amendments has NOT expired. <input checked="" type="checkbox"/> have not been made and will not be made. <p>8. <input type="checkbox"/> An English language translation of the amendments to the claims under PCT Article 19 (35 U.S.C. 371(c)(3)).</p> <p>9. <input type="checkbox"/> An oath or declaration of the inventor(s) (35 U.S.C. 371(c)(4)).</p> <p>10. <input checked="" type="checkbox"/> An English language translation of the annexes of the International Preliminary Examination Report under PCT Article 36 (35 U.S.C. 371(c)(5)).</p>		
Items 11. to 20. below concern document(s) or information included:		
<p>11. <input checked="" type="checkbox"/> An Information Disclosure Statement under 37 CFR 1.97 and 1.98-1449 and International Search Report w/ cited documents.</p> <p>12. <input type="checkbox"/> An assignment document for recording. A separate cover sheet in compliance with 37 CFR 3.28 and 3.31 is included.</p> <p>13. <input checked="" type="checkbox"/> A FIRST preliminary amendment.</p> <p>14. <input type="checkbox"/> A SECOND or SUBSEQUENT preliminary amendment.</p> <p>15. <input type="checkbox"/> A substitute specification.</p> <p>16. <input type="checkbox"/> A change of power of attorney and/or address letter.</p> <p>17. <input type="checkbox"/> A computer-readable form of the sequence listing in accordance with PCT Rule 13ter.2 and 35 U.S.C. 1.821-1.825.</p> <p>18. <input type="checkbox"/> A second copy of the published international application under 35 U.S.C. 154(d)(4).</p> <p>19. <input type="checkbox"/> A second copy of the English language translation of the international application under 35 U.S.C. 154(d)(4).</p> <p>20. <input checked="" type="checkbox"/> Other items or information: Two (2) sheets of formal drawings PCT/IPEA/409</p>		

U.S. APPLICATION NO (if known, sec 37 CFR 1.5) 09/869119	INTERNATIONAL APPLICATION NO PCT/SE00/00097	ATTORNEY'S DOCKET NUMBER 0104-0347P
<p>21. <input checked="" type="checkbox"/> The following fees are submitted:</p> <p>BASIC NATIONAL FEE (37 CFR 1.492(a)(1)-(5): Neither international preliminary examination fee (37 CFR 1.482) nor international search fee (37 CFR 1.445(a)(2)) paid to USPTO and International Search Report not prepared by the EPO or JPO. \$1,000.00</p> <p>International preliminary examination fee (37 CFR 1.482) not paid to USPTO but International Search Report prepared by the EPO or JPO \$860.00</p> <p>International preliminary examination fee (37 CFR 1.482) not paid to USPTO but international search fee (37 CFR 1.445(a)(2)) paid to USPTO. \$710.00</p> <p>International preliminary examination fee (37 CFR 1.482) paid to USPTO but all claims did not satisfy provisions of PCT Article 33(1)-(4) \$690.00</p> <p>International preliminary examination fee (37 CFR 1.482) paid to USPTO and all claims satisfied provisions of PCT Article 33(1)-(4). \$100.00</p>		CALCULATIONS PTO USE ONLY
ENTER APPROPRIATE BASIC FEE AMOUNT =		
Surcharge of \$130.00 for furnishing the oath or declaration later than <input type="checkbox"/> 20 <input checked="" type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492(e)).		\$ 1000.00
CLAIMS	NUMBER FILED	NUMBER EXTRA
Total Claims	22 - 20 =	2
Independent Claims	3 - 3 =	0
MULTIPLE DEPENDENT CLAIM(S) (if applicable)		None
TOTAL OF ABOVE CALCULATIONS =		\$ 1166.00
<input type="checkbox"/> Applicant claims small entity status. See 37 CFR 1.27. The fees indicated above are reduced by 1/2.		\$ 0
SUBTOTAL =		\$ 1166.00
Processing fee of \$130.00 for furnishing the English translation later than <input type="checkbox"/> 20 <input type="checkbox"/> 30 months from the earliest claimed priority date (37 CFR 1.492(f)).		\$ 0
TOTAL NATIONAL FEE =		\$ 1166.00
Fee for recording the enclosed assignment (37 CFR 1.21(h)). The assignment must be accompanied by an appropriate cover sheet (37 CFR 3.28, 3.31). \$40.00 per property		\$ 0
TOTAL FEES ENCLOSED =		\$ 1166.00
		Amount to be: refunded \$ charged \$
<p>a. <input checked="" type="checkbox"/> A check in the amount of \$ 1166.00 to cover the above fees is enclosed.</p> <p>b. <input type="checkbox"/> Please charge my Deposit Account No. _____ in the amount of \$ _____ to cover the above fees. A duplicate copy of this sheet is enclosed.</p> <p>c. <input checked="" type="checkbox"/> The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. <u>02-2448</u>.</p>		
<p>NOTE: Where an appropriate time limit under 37 CFR 1.494 or 1.495 has not been met, a petition to revive (37 CFR 1.137(a) or (b)) must be filed and granted to restore the application to pending status.</p> <p>Send all correspondence to: Birch, Stewart, Kolasch & Birch, LLP or Customer No. 2292 P.O. Box 747 Falls Church, VA 22040-0747 (703)205-8000</p> <p>Date: June 25, 2001</p> <p>By <u>James M. Slattery</u> <i>Aug 2001</i> James M. Slattery, #28,380</p>		

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PATENT
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IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: EKBERG, Peter Conf.:

Int'l. Appl. No.: PCT/SE00/00097

Appl. No.: NEW Group:

Filed: June 25, 2001 Examiner:

For: SYSTEM FOR PRODUCTION OF LARGE AREA
DISPLAY PANELS WITH IMPROVED
PRECISION

PRELIMINARY AMENDMENT

BOX PATENT APPLICATION

Assistant Commissioner for Patents
Washington, DC 20231

June 25, 2001

Sir:

The following Preliminary Amendments and Remarks are respectfully submitted in connection with the above-identified application.

AMENDMENTS

IN THE SPECIFICATION:

Please amend the specification as follows:

Before line 1, insert --This application is the national phase under 35 U.S.C. § 371 of PCT International Application No. PCT/SE00/00097 which has an International filing date of January 18, 2000, which designated the United States of America and was published in English.--

IN THE CLAIMS:

Please amend the claims as follows:

3. (Amended) A method according to claim 1, whereby the measuring is made after processing steps, such as development, etching, blasting or high-temperature processing, following the exposure.

4. (Amended) A method according to claim 1, whereby the first and the second mask are based on the same input data.

5. (Amended) A method according to claim 1, whereby the first mask is a reference mask based on reference input data, whereas the second mask is based on the actual product data.

6. (Amended) A method according to claim 1, whereby the compensation used is a statistical mean value of the compensation according to the measurement and compensation according to prior measurements.

7. (Amended) A method according to claim 1, wherein at least one additional measurement is made during the process, whereby the compensations is a statistical mean value of compensation parts related to the process before the first measurement, and the process between the measurements.

8. (Amended) A method according to claim 1, whereby the thickness of the sensitive layer before the exposure on the mask blank or on the substrate is measured, whereby said measurement data are used for additional compensation.

9. (Amended) A method according to claim 1, whereby already existing patterns on the substrate is measured prior to the exposure, whereby said measurement is used for additional compensation.

10. (Amended) A method according to claim 1, whereby said method is performed once for each substrate batch used in said fabrication.

11. (Amended) A method according to claim 1, whereby the measurement comprises measurement of position errors and pattern line width errors.

12. (Amended) A method according to claim 1, whereby said compensation is performed by time offsets or room offsets in the pattern writer used for producing the second mask.

15. (Amended) A system according to claim 13, comprising at least one additional measuring device, whereby the compensations is a statistical mean value of compensation parts related to the process before the first measurement, and the process between the measurements.

16. (Amended) A system according to claim 13, whereby the first and the second mask generator (1) are the same device.

17. (Amended) A system accoding to claim 13, further comprising a second measuring device (4) for measuring the thickness of the light sensitivie layer on the substrate prior to the exposure, whereby said measurement is used for additional compensation.

18. (Amended) A system according to claim 13, further comprising a third measuring device (4) for measuring of existing

patterns on the substrate prior to the exposure, whereby said measurement is used for additional compensation.

19. (Amended) A system according to claim 13, whereby the first measuring device comprises means for measurement of position errors and pattern line width errors.

20. (Amended) A system according to claim 13, Whereby said mask generator comprises a pattern writer, being controllable for said compensations by means of time offsets during the writing.

REMARKS

The specification has been amended to provide a cross-reference to the previously filed International Application. The claims have also been amended to delete multiple dependencies and to place the application into better form for examination. Entry of the present amendment and favorable action on the above-identified application are earnestly solicited.

Attached hereto is a marked-up copy of the changes made to the application by this Amendment.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. § 1.16 or under 37 C.F.R. § 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP

By Joe M. Slattery Reg. No. 32334
for James M. Slattery, #28,380

P.O. Box 747
Falls Church, VA 22040-0747
(703) 205-8000

JMS/rem
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(Rev. 02/12/01)

VERSION WITH MARKINGS SHOWING CHANGES MADE

The specification has been amended to provide cross-referencing to the International Application.

The claims have been amended as follows:

3. (Amended) A method according to claim 1 [or 2], whereby the measuring is made after processing steps, such as development, etching, blasting or high-temperature processing, following the exposure.

4. (Amended) A method according to [one of the claims 1-3] claim 1, whereby the first and the second mask are based on the same input data.

5. (Amended) A method according to [one of the claims 1-3] claim 1, whereby the first mask is a reference mask based on reference input data, whereas the second mask is based on the actual product data.

6. (Amended) A method according to [any one of the claims above] claim 1, whereby the compensation used is a statistical mean value of the compensation according to the measurement and compensation according to prior measurements.

7. (Amended) A method according to [any one of the claims above] claim 1, wherein at least one additional measurement is made during the process, whereby the compensation is a statistical mean value of compensation parts related to the

process before the first measurement, and the process between the measurements.

8. (Amended) A method according to [any one of the claims above] claim 1, whereby the thickness of the sensitive layer before the exposure on the mask blank or on the substrate is measured, whereby said measurement data are used for additional compensation.

9. (Amended) A method according to [any one of the claims above] claim 1, whereby already existing patterns on the substrate is measured prior to the exposure, whereby said measurement is used for additional compensation.

10. (Amended) A method according to [any one of the claims above] claim 1, whereby said method is performed once for each substrate batch used in said fabrication.

11. (Amended) A method according to [any one of the claims above] claim 1, whereby the measurement comprises measurement of position errors and pattern line width errors.

12. (Amended) A method according to [any one of the claims above] claim 1, whereby said compensation is performed by time offsets or room offsets in the pattern writer used for producing the second mask.

15. (Amended) A system according to claim 13 [or 14], comprising at least one additional measuring device, whereby the compensations is a statistical mean value of compensation parts related to the process before the first measurement, and the process between the measurements.

16. (Amended) A system according to [one of the claims 13-15] claim 13, whereby the first and the second mask generator (1) are the same device.

17. (Amended) A system according to [any one of the claims 13-16] claim 13, further comprising a second measuring device (4) for measuring the thickness of the light sensitive layer on the substrate prior to the exposure, whereby said measurement is used for additional compensation.

18. (Amended) A system according to [any one of the claims 13-17] claim 13, further comprising a third measuring device (4) for measuring of existing patterns on the substrate prior to the exposure, whereby said measurement is used for additional compensation.

19. (Amended) A system according to [any one of the claims 13-18] claim 13, whereby the first measuring device comprises means for measurement of position errors and pattern line width errors.

20. (Amended) A system according to [any one of the claims 13-19] claim 13, Whereby said mask generator comprises a pattern writer, being controllable for said compensations by means of time offsets during the writing.

SYSTEM FOR PRODUCTION OF LARGE AREA DISPLAY PANELS
WITH IMPROVED PRECISION

Field of the invention

The present invention relates to a method and a system for producing large area display panels with improved precision.

5

Background of the invention

It is known beforehand in the art to produce large area display panels. This is typically accomplished by first producing a mask according to input data, and subsequently to use said mask in a microlithographic exposing device to produce panels with said pattern. The precision for the panels are of utmost importance, and much effort is taken to improve the precision in the pattern production as well as in the exposure of the panels. E.g. the laser writers often used for mask production comprises compensation means to compensate for scale errors, orthogonality errors, stage bows, local offset errors etc.

However, there are still significant precision errors, because of different conditions and surroundings for the different production devices, systematic errors, errors caused by the processing of the plate, such as the development, etching, blasting and high temperature processing steps. Further, large area display panels are extremely sensitive for errors, while even very small deviations from the intended pattern may be visible. These errors make the production costly and tedious, and give rise to a large number of rejected defect panels.

30 Summary of the invention

It is therefore an object of the present invention to provide a method and a system for producing large area display panels with improved precision.

5 This object is achieved with a method and a system according to the appended claims.

Brief description of the drawings

For exemplifying purposes, the invention will be described in closer detail in the following with 10 reference to embodiments thereof illustrated in the attached drawings, wherein:

Fig 1 is a mask producing apparatus according to the prior art;

15 Fig 2 is a schematic view of a system according to one embodiment of the invention; and

Fig 3 is a schematic flow chart of a method according to one embodiment of the invention.

Description of preferred embodiments

20 Referring to fig 2, a first embodiment of the system for producing large area display panels according to the invention. The system could be used for producing shadow masks for conventional CRT (Cathode Ray Tube) displays, but is especially useful for producing TFT (Thin Film 25 Transistor), CF (Color Filter), PDP (Plasma Display Panel) or PALC (Plasma-addressed liquid crystal) displays.

The system comprises a first mask producing means 1 for producing a mask with a predetermined pattern 30 according to input data. The mask producing means is preferably a microlithographic writing device for writing with high precision on photosensitive substrates. The term writing should be understood in a broad sense, meaning exposure of photoresist and photographic 35 emulsion, but also the action of light on other light

5 sensitive media such as dry-process paper, by ablation or chemical processes activated by light or heat. Light is not limited to mean visible light, but a wide range of wavelengths from infrared to extreme UV. Such a mask
10 producing apparatus is previously known from e.g. EP 0 467 076 by the same applicant. In general the apparatus comprises, as is shown in fig 1, a light source 51, such as a laser, a first lens 52 to contract the light beams, a modulator 53 to produce the desired pattern to be
15 written, the modulator being controlled according to input data, a reflecting mirror 54 to direct the beams towards the substrate 56, and a lens 55 to contract the beams before it reaches the substrate. The mirror 54 is used for the scanning operation to sweep the beam along
20 scan lines on the substrate. Instead of a mirror, other scanning means may be used, such as a rotating polygon, rotating prism, rotating hologram, an acousto-optic deflector, an electro-optic deflector, a galvanometer or any similar device. It is also possible to use raster
25 scanning or spatial light modulators. Further, the substrate is preferably arranged on an object table which has a motion in two orthogonal directions relative to the optical writing system, by means of two electrical servo motors.

25 The system according to the invention further comprises microlithographic exposing means 2 for exposing a photosensitive panel substrate with light and with use of the mask to impose the pattern of the mask on the substrate, whereby said substrate has a layer being
30 sensitive to said light. Several such exposing means are also previously known in the art. The exposing means could be of the contact copy type, proximity exposure type, or a projection aligner. The system according to the invention could also be used in a direct writer,
35 whereby the compensation is not made in a physical mask,

but in a data mapping controlling the writing beam. For TFT and CF display panels projection aligners are usually used, and for PDP and PALC the contact or proximity type are frequently used.

5 Furthermore, the system comprises measuring means 3 for measuring the pattern on the substrate and detecting deviations relative to the intended pattern as given by the input data. This could be done by measuring the geometrical position of the pattern, preferably at some
10 reference positions, to get a so called registration mapping, and compare it with the intended pattern which is deducible from the input data. Further, the width of lines in the pattern, the so called CD (Critical dimension), could be measured. Measuring equipment is
15 commercially available, and for example the equipment could comprise a CCD-camera or be based on interferometry.

From the measuring means 3 a distortion control signal is sent to a second mask producing means 4. This
20 second mask producing means could be a separate apparatus, but is preferably the same as the first mask producing means 1. This second mask producing means is fed with input data describing the intended mask pattern to be written, and is also fed with the distortion
25 control signal from the measuring means 3, whereby the writing process for producing the second mask is controlled to modify the pattern to compensate for the measured deviations, and thus compensate for production distortions. The measurement is preferably made after the
30 subsequent processing steps of the panel as well, i.e. the development, blasting and/or etching, whereby systematic errors from these processes are taken care of in the compensation as well.

The compensation in the mask writer could be
35 accomplished in different ways. In a writer of the type

described above, with an object table continuously moving in a slow strip direction and a scanner sweeping in a fast scanning direction, the compensation could be made according to a surface mapping. According to this mapping
5 the compensation in the scanning direction could be accomplished by e.g. offsetting the starting time of the beam during the scanning. In the stripe direction the compensation could also be made by time offsets, either directly or indirectly by means of different ramp
10 functions. There are also other possible way to accomplish such compensation. For example the compensation could be made by controlling the servo motors for the object table, by adjustment of the time dependent angle of the scanners, by changing the input
15 data or by controlling an internal control unit such as piezoelectrically controlled mirrors.

However, if a direct writer is used, the same type of compensation could be made in real time.

Compensation for deviations in the line width, CD,
20 could be accomplished in the same way as deviations in the registration. However, this compensation could also be made by changes in the power of the writing beam, i.e. the exposing dose, by changing the laser output or having an analog modulator. This compensation could be
25 accomplished by means of a herefore adapted dose mapping to control the dose.

When the second mask is used in the same exposing means 2 all systematic errors depending on different temperature conditions, errors in the exposing means
30 etc., are compensated for, and the pattern precision of the produced display panels are greatly improved.

The first mask could either contain the same pattern as the intended pattern for the second mask, i.e. the pattern not being compensated, or contain a reference
35 pattern, intended for deviation measure only.

Further, error data could be accumulated, and a rolling means value could be used for the compensation. The error compensation could also be a combination of several different part error compensations. Those part 5 compensations could be based on the premises for the process, e.g. which stepper and type of glass that is being used. Hereby the total error compensation could be a combination of one or several error compensations for each process step.

10 Above, a system for passive distortion control has been described. In this system compensation is made for the processes and equipment being used in the system. However, the compensation is not adapted for different panel substrates. In this passive system a measurement to 15 alter the distortion compensation is preferably made once for every new batch of substrates, and thereafter the same mask is used for producing all the panels in the batch. This passive distortion control is specifically useful for production of TFT or CF displays. The 20 requested precision for the patterns on the mask for this production is extremely high, and the masks are very difficult, and thereby expensive, to manufacture. On the other hand the masks last for a long time in this production.

25 The system according to the invention could also comprise second measuring means 4 for measuring the thickness of the light sensitive layer on the substrate prior to the exposure, whereby said measurement is also used for said compensation. Hereby the compensation is 30 adapted for varying resist layers between different batches of substrates. Such batch wise compensation could also be accomplished with use of data specified by the manufacturer.

35 This second measuring means 4 could also be used for measuring each and every panel substrate that is going to

be exposed, and thereafter adapt the process for each individual panel. Hereby the system could compensate for varying glass quality in different panels, varying thickness and quality of the resist or emulsion of the 5 substrate area, different form variations etc. This active distortion control is especially useful for production of PDP or PALC display panels, where the masks are comparably easy and inexpensive to produce. This method could also be used for direct writers.

10 In the active distortion control the panel is initially measured, regarding e.g. resist thickness. Many such measuring methods are available for someone skilled in the art, e.g. a test exposure, dosimetry, of the substrate with different doses, by profilometry, 15 interferometry, confocal microscopy, by an interferometric method or the like. The shape of the substrate could also be initially measured, and this could be accomplished by known methods such as moiré interferometry, projected fringes, laser triangulation, 20 ordinary interferometry etc. Preferably already existing patterns are also initially measured, whereas such exists. Display panels are usually exposed in several separate steps, typically 3-7 exposing steps, and normally the same exposing station is used for all the 25 exposures. By writing masks with compensation for individual errors in different station the display producer could schedule the production more freely, independent of which stations that is used.. This is of great importance for making the production more efficient 30 and the utilization of the stations better.

Referring now to fig 2, a method for producing large area display panels according to the invention, and with use of the above-mentioned system will be described.

35 The method according to the invention comprises a first step S1 in which a mask with a predetermined

pattern according to input data is produced. Thereafter the mask is used for microlithographically exposing a photosensitive substrate with light to impose the pattern of the mask on the substrate, whereby said substrate has a layer being sensitive to said light, in step S2. The exposed pattern is then measured, possibly after several subsequent processing steps, or even in the finished product, in S3, to detect deviations of the exposed pattern relative to the intended pattern as given by the input data. In step S4 a distortion control mapping is then produced, to be used in step S5 during production of a second mask having a pattern according to input data and modified to diminish the measured deviations, and thus to compensate for production distortions. In the last step S6 the second modified mask is then used in a photolithographic fabrication of display panels. Similar compensation may be used in a direct writer, where the compensation could be made in a data mapping.

Further, the present invention relates to a large-area pattern generator, for producing e.g. masks for producing large-area display panels such as is described above. The large-area pattern generator according to the invention comprises an exposing system for exposing a substrate with radiant energy and according to input pattern data to impose a predetermined pattern on the substrate, whereby said substrate has a layer being sensitive to said radiant energy, as is previously described. It further comprises a geometry-correcting system for correcting the pattern being imposed in the substrate according to digital distortion data, comprising effectuators for controlling at least one of the feeding of input pattern data in the data path, the movement of the substrate or the pattern placement on the substrate, as is likewise described in the foregoing.

The invention has above been described with reference to a microlithography system, where photons (light) is used as the radiant energy. However, other types of radiant energy may be used as well, such as charged particles, electrons, ions, EUV (Extreme Ultra Violet), and other radiant energies suitable for substrate exposure. Further, other types of pattern generator may be used. For example, the pattern generator may use an acousto-optic modulator to control the radiant energy according to input data, as well as a voltage controlled modulator or an SLM (Spatial Light Modulator). If an SLM is used, the pattern generator may either be of the type using raster scanning or the type using shaped beams.

The invention makes the production of large area display panels more efficient and cost effective, at the same time as the pattern precision is improved. However several variations of the above-mentioned embodiments are possible, and obvious for a person skilled in the art.

Such obvious modifications must be considered as being part of the invention, as it is defined by the following claims.

CLAIMS

1. A method for producing large area display panels comprising the steps of:

5 producing a mask with a predetermined pattern according to input data (S1);

exposing a substrate with a radiant energy and with use of the mask to impose the pattern of the mask on the substrate, whereby said substrate has a layer being
10 sensitive to said radiant energy (S2);

measuring the pattern on the substrate and detecting deviations, and at least position errors, relative to the intended pattern as given by the input data (S3);

15 producing a second mask with a pattern according to second input data and modified to diminish the measured deviations, and at least said measured and detected position errors, and thus compensate for production distortions (S5);

20 using said modified mask in a subsequent fabrication of large area display panels (S6).

2. A method according to claim 1, whereby the radiant energy is light, used for microlithographically exposing a photosensitive substrate.

25 3. A method according to claim 1 or 2, whereby the measuring is made after processing steps, such as development, etching, blasting or high-temperature processing, following the exposure.

30 4. A method according to one of the claims 1-3, whereby the first and the second mask are based on the same input data.

5. A method according to one of the claims 1-3, whereby the first mask is a reference mask based on reference input data, whereas the second mask is based on the actual product data.

35 6. A method according to any one of the claims above, whereby the compensation used is a statistical mean value of the compensation according to the

measurement and compensations according to prior measurements.

7. A method according to any one of the claims above, wherein at least one additional measurement is 5 made during the process, whereby the compensations is a statistical mean value of compensation parts related to the process before the first measurement, and the process between the measurements.

8. A method according to any one of the claims 10 above, whereby the thickness of the sensitive layer before the exposure on the mask blank or on the substrate is measured, whereby said measurement data are used for additional compensation.

9. A method according to any one of the claims 15 above, whereby already existing patterns on the substrate is measured prior to the exposure, whereby said measurement is used for additional compensation.

10. A method according to any one of the claims above, whereby said method is performed once for each 20 substrate batch used in said fabrication.

11. A method according to any one of the claims above, whereby the measurement comprises measurement of position errors and pattern line width errors.

12. A method according to any one of the claims 25 above, whereby said compensation is performed by time offsets or room offsets in the pattern writer used for producing the second mask.

13. A system for producing large area display panels comprising:

30 a first mask generator (1) for producing a mask with a predetermined pattern according to input data;

an exposing means (2) for exposing a substrate with radiant energy and with use of a mask to impose the pattern of the mask on the substrate, whereby said 35 substrate has a layer being sensitive to said radiant energy;

a measuring device (3) for measuring the pattern on

the substrate and detecting deviations, and at least position errors, relative to the intended pattern as given by the input data;

5 a second mask generator (1) for producing a second mask according to second input data, and being controllable according to said measurement, to modify the pattern on the mask to compensate for the measured deviations, and at least said measured and detected position errors, and thus compensate for production 10 distortions.

14. A system according to claim 13, whereby the radiant energy is light, for microlithographically exposing a photosensitive substrate.

15. A system according to claim 13 or 14, comprising at least one additional measuring device, whereby the compensations is a statistical mean value of compensation parts related to the process before the first measurement, and the process between the measurements.

16. A system according to one of the claims 13-15, 20 whereby the first and the second mask generator (1) are the same device.

17. A system according to any one of the claims 13-16, further comprising a second measuring device (4) for measuring the thickness of the light sensitive layer on 25 the substrate prior to the exposure, whereby said measurement is used for additional compensation.

18. A system according to any one of the claims 13-17, further comprising a third measuring device (4) for measuring of existing patterns on the substrate prior to 30 the exposure, whereby said measurement is used for additional compensation.

19. A system according to any one of the claims 13-18, whereby the first measuring device comprises means for measurement of position errors and pattern line width 35 errors.

20. A system according to any one of the claims 13-19, whereby said mask generator comprises a pattern

writer, being controllable for said compensations by means of time offsets during the writing.

21. A large-area pattern generator comprising:
 - an exposing system for exposing a substrate with radiant energy and according to input pattern data to impose a predetermined pattern on the substrate, whereby said substrate has a layer being sensitive to said radiant energy;
 - a geometry-correcting system for correcting the pattern being imposed in the substrate according to digital distortion data, comprising effectuators for controlling at least one of the feeding of input pattern data in the data path, the movement of the substrate or the pattern placement on the substrate.
- 15 22. A pattern generator according to claim 21, wherein the distortion data is generated by measuring a pattern of a previous exposure and detecting deviations relative to the intended pattern as given by the input data.

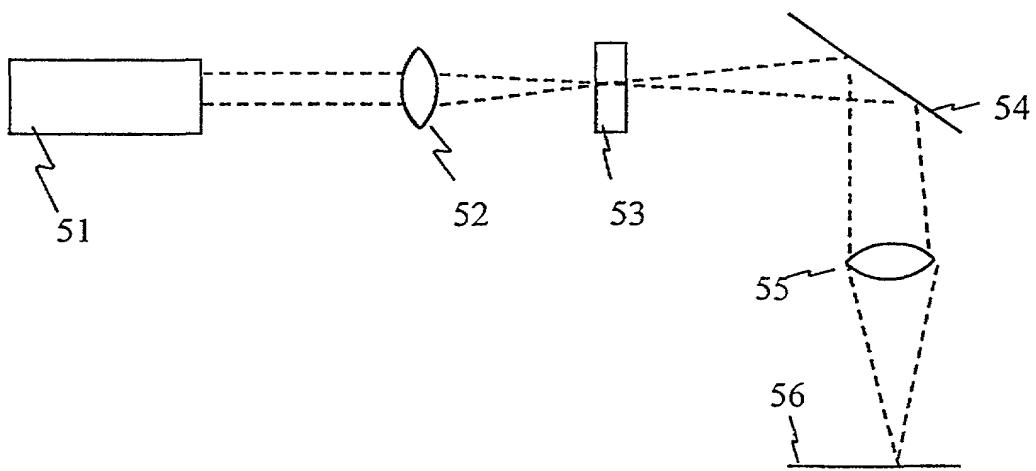


Fig 1 - Prior art

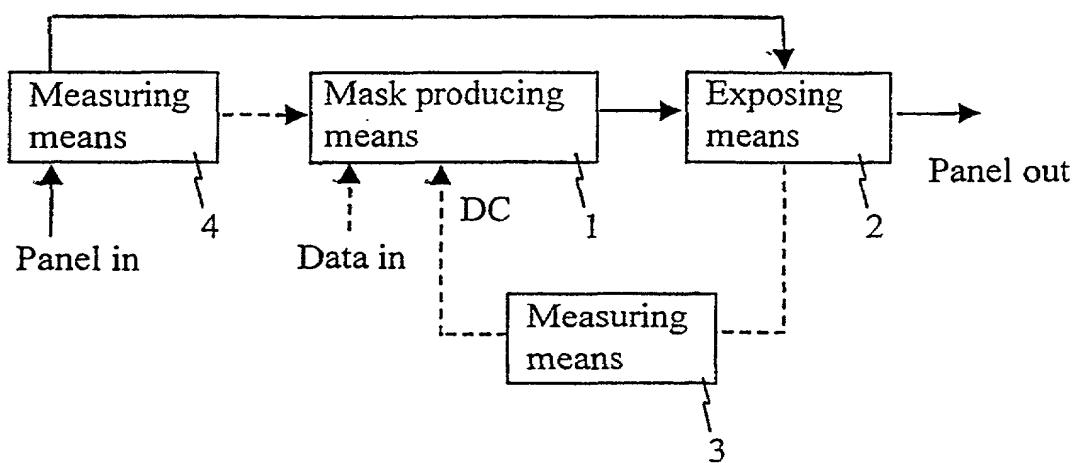


Fig 2

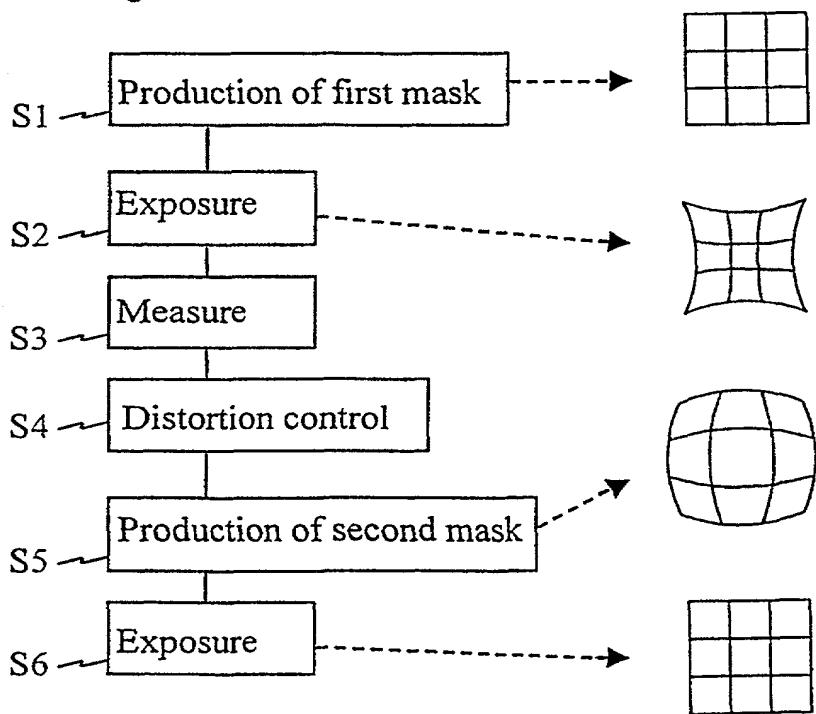


Fig 3

Attorney Docket No.

BIRCH, STEWART, KOLASCH & BIRCH, LLP

0104-0347P

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**COMBINED DECLARATION AND POWER OF ATTORNEY
FOR PATENT AND DESIGN APPLICATIONS**

As a below named inventor, I hereby declare that: my residence, post office address and citizenship are as stated next to my name; that I verify believe that I am the original, first and sole inventor (if only one inventor is named below) or an original, first and joint inventor (if plural inventors are named below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Insert Title:

Fill in Appropriate
Information -
For Use Without
Specification
Attached:

SYSTEM FOR PRODUCTION OF LARGE AREA DISPLAY PANELS WITH IMPROVED PRECISION

the specification of which is attached hereto. If not attached hereto,
the specification was filed on June 25 2001 as
United States Application Number ;
and amended on June 25 2001 (if applicable) and/or
the specification was filed on 18 January 2000 as PCT
International Application Number PCT/SE00/00097; and was
amended under PCT Article 19 on (if applicable)

I hereby state that I have reviewed and understand the contents of the above-identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to patentability as defined in Title 37, Code of Federal Regulations, §1.56.

I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application, that the same was not in public use or on sale in the United States of America more than one year prior to this application, that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representative or assigns more than twelve months (six months for designs) prior to this application, and that no application for patent or inventor's certificate on this invention has been filed in any country foreign to the United States of America prior to this application by me or my legal representatives or assigns, except as follows.

I hereby claim foreign priority benefits under Title 35, United States Code, §119(a)-(d) of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)

Priority Claimed

Insert Priority
Information:
(if appropriate)

<u>9900114-1</u> (Number)	<u>Sweden</u> (Country)	<u>01/18/1999</u> (Month/Day/Year Filed)	<input checked="" type="checkbox"/> Yes	<input type="checkbox"/> No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Month/Day/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Month/Day/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No
<u> </u> (Number)	<u> </u> (Country)	<u> </u> (Month/Day/Year Filed)	<input type="checkbox"/> Yes	<input type="checkbox"/> No

I hereby claim the benefit under Title 35, United States Code, §119(e) of any United States provisional applications(s) listed below.

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(if any)

<u> </u> (Application Number)	<u> </u> (Filing Date)
<u> </u> (Application Number)	<u> </u> (Filing Date)

All Foreign Applications, if any, for any Patent or Inventor's Certificate Filed More than 12 Months (6 Months for Designs) Prior to the Filing Date of This Application:

Insert Requested
Information:
(if appropriate)

Country	Application Number	Date of Filing (Month/Day/Year)
<u> </u>	<u> </u>	<u> </u>
<u> </u>	<u> </u>	<u> </u>

I hereby claim the benefit under Title 35, United States Code, §120 of any United States and/or PCT application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States and/or PCT application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose information which is material to the patentability as defined in Title 37, Code of Federal Regulations, §1.56 which became available between the filing date of the prior application and the national or PCT international filing date of this application.

Insert Prior U.S.
Application(s):
(if any)

<u> </u> (Application Number)	<u> </u> (Filing Date)	<u> </u> (Status - patented, pending, abandoned)
<u> </u> (Application Number)	<u> </u> (Filing Date)	<u> </u> (Status - patented, pending, abandoned)

I hereby appoint the following attorneys to prosecute this application and/or an international application based on this application and to transact all business in the Patent and Trademark Office connected therewith and in connection with the resulting patent based on instructions received from the entity who first sent the application papers to the attorneys identified below, unless the inventor(s) or assignee provides said attorneys with a written notice to the contrary:

Raymond C. Stewart (Reg. No. 21,066)	Terrell C. Birch (Reg. No. 19,382)
Joseph A. Kolasch (Reg. No. 22,463)	James M. Slattery (Reg. No. 28,380)
Bernard L. Sweeney (Reg. No. 24,448)	Michael K. Mutter (Reg. No. 29,680)
Charles Gorenstein (Reg. No. 29,271)	Gerald M. Murphy, Jr. (Reg. No. 28,977)
Leonard R. Svensson (Reg. No. 30,330)	Terry L. Clark (Reg. No. 32,644)
Andrew D. Meikle (Reg. No. 32,868)	Marc S. Weiner (Reg. No. 32,181)
Joe McKinney Muncy (Reg. No. 32,334)	Donald J. Daley (Reg. No. 34,313)
John W. Bailey (Reg. No. 32,881)	John A. Castellano (Reg. No. 35,094)
Gary D. Yacura (Reg. No. 35,416)	

Send Correspondence to:

BIRCH, STEWART, KOLASCH & BIRCH, LLP or **Customer No. 2292**
P.O. Box 747 • Falls Church, Virginia 22040-0747
Telephone: (703) 205-8000 • Facsimile: (703) 205-8050

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Full Name of First
or Second Inventor:
Insert Name of
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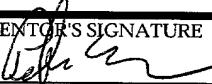
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Address

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Full Name of Second
Inventor, if any:
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Full Name of Fourth
Inventor, if any:
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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

GIVEN NAME/FAMILY NAME Peter EKBERG	INVENTOR'S SIGNATURE 	DATE* 31/7-2001
Residence (City, State & Country) Lidingo, Sweden	CITIZENSHIP Swedish	
MAILING ADDRESS (Complete Street Address including City, State & Country) Norsbacken 5, SE-181 31, Lidingo, Sweden		
GIVEN NAME/FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Residence (City, State & Country)	CITIZENSHIP	
MAILING ADDRESS (Complete Street Address including City, State & Country)		
GIVEN NAME/FAMILY NAME	INVENTOR'S SIGNATURE	DATE*
Residence (City, State & Country)	CITIZENSHIP	
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